

Positive Voltage Regulators

■ GENERAL DESCRIPTION

The XC6201 series are highly precise, low power consumption, positive voltage regulators manufactured using CMOS and laser trimming technologies.

The series provides large currents with a significantly small dropout voltage.

The XC6201 consists of a current limiter circuit, a driver transistor, a precision reference voltage and an error amplifier. Output voltage is selectable in 0.1V steps between 1.3V ~ 6.0V.

SOT-25, SOT-89 and USP-6B packages are available.

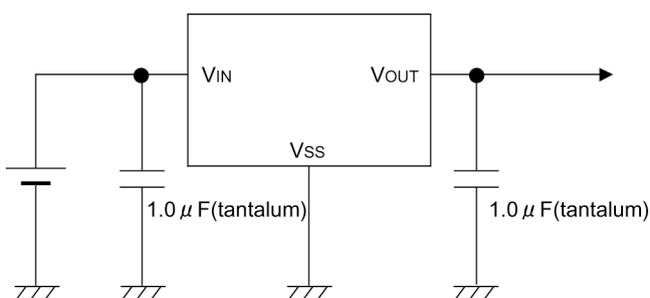
■ APPLICATIONS

- Smart phones / Mobile phones
- Portable game consoles
- Digital still cameras / Camcorders
- Digital audio equipment
- Reference voltage sources
- Multi-function power supplies

■ FEATURES

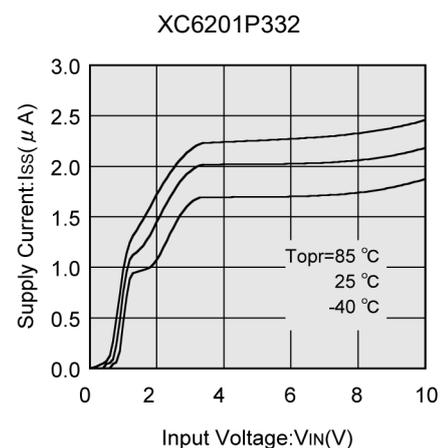
Maximum Output Current	: 200mA
Dropout Voltage	: 0.16V @ 100mA : 0.40V @ 200mA
Maximum Operating Voltage	: 10V
Output Voltage Range	: 1.3V ~ 6.0V (0.1V increments)
Fixed Voltage Accuracy	: $\pm 1\%$ ($V_{OUT(T)} \geq 2.0V$) : $\pm 2\%$
Low Power Consumption	: 2.0 μ A
Operating Ambient Temperature	: -40°C ~ 85°C
Packages	: SOT-25, SOT-89 USP-6B
Environmentally Friendly	: EU RoHS Compliant, Pb Free
Tantalum or Ceramic Capacitor compatible	

■ TYPICAL APPLICATION CIRCUIT

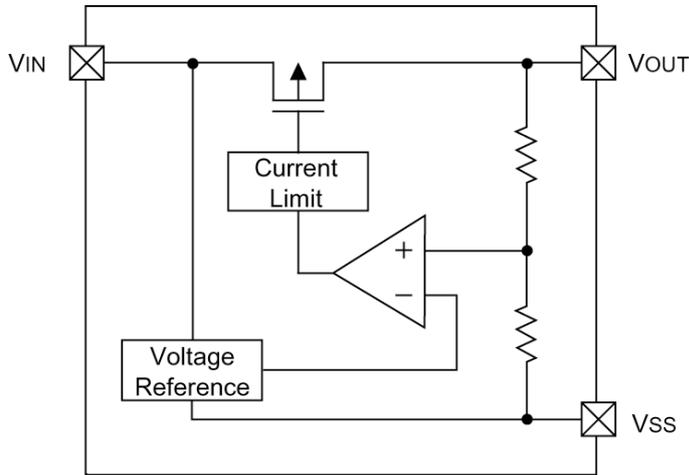


■ TYPICAL PERFORMANCE CHARACTERISTICS

- Supply Current vs. Input Voltage



■ BLOCK DIAGRAM



■ PRODUCT CLASSIFICATION

● Ordering Information

XC6201P ③④⑤⑥⑦-⑧^(*)

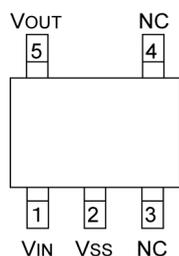
↑ ↑
① ②

DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
①	Product Number	01	-
②	Type of Regulator	P	3-pin regulator
③④	Output Voltage	13 ~ 60	e.g. 30 : 3.0V 50 : 5.0V
⑤	Output Voltage Accuracy	1	±1%
		2	±2%
⑥⑦-⑧	Packages (Order Unit)	MR-G	SOT-25 (3,000pcs/Reel)
		PR-G	SOT-89 (1,000pcs/Reel)
		DR-G	USP-6B (3,000pcs/Reel)

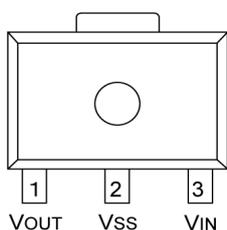
^(*) The "-G" suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant.

* ±1% accuracy can be set at $V_{OUT(T)} \geq 2.0V$.

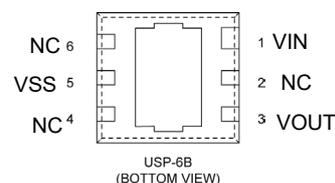
■ PIN CONFIGURATION



SOT-25
(TOP VIEW)



SOT-89
(TOP VIEW)



*The dissipation pad for the USP-6B package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the VSS (No.5) pin.

■ PIN ASSIGNMENT

PIN NUMBER			PIN NAME	FUNCTION
SOT-25	SOT-89	USP-6B		
5	1	3	VOUT	Output
2	2	5	VSS	Ground
1	3	1	VIN	Power Input
3, 4	-	2,4,6	NC	No Connection

■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAMETER	SYMBOL	RATINGS	UNITS
Input Voltage	V _{IN}	12.0	V
Output Current	I _{OUT}	500	mA
Output Voltage	V _{OUT}	V _{SS} - 0.3 ~ V _{IN} + 0.3	V
Power Dissipation	Pd	250 (IC only)	mW
		760 (JESD51-7 board) ^(*)	
		500 (IC only)	
		1000 (40mm x 40mm Standard board) ^(*)	
		120 (IC only)	
1000 (40mm x 40mm Standard board) ^(*)			
Operating Temperature	T _{opr}	-40 ~ 85	°C
Storage Temperature	T _{stg}	-55 ~ 125	°C

Each voltage rating is based on V_{SS}.

^(*) The power dissipation figure shown is PCB mounted and is for reference only. Please refer to PACKAGING INFORMATION for the mounting condition.

ELECTRICAL CHARACTERISTICS

XC6201P132 $V_{OUT(T)}=1.3V$ (*1)

$T_a=25^\circ C$

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	$V_{OUT(E)}$ (*2)	$V_{IN}=2.3V$ $I_{OUT}=10mA$	1.274	1.300	1.326	V	②
Maximum Output Current	I_{OUTmax}	$V_{IN}=2.3V$ $V_{OUT(E)} \geq 1.17V$	60	-	-	mA	②
Load Regulation	ΔV_{OUT}	$V_{IN}=2.3V$ $1mA \leq I_{OUT} \leq 30mA$	-	10	30	mV	②
Dropout Voltage (*3)	Vdif1	$I_{OUT}=30mA$	-	200	600	mV	②
	Vdif2	$I_{OUT}=60mA$	-	500	810		
Supply Current	I_{SS}	$V_{IN}=2.3V$	-	2.0	5.0	μA	①
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot \Delta V_{OUT}}$	$I_{OUT}=10mA$ $2.3V \leq V_{IN} \leq 10.0V$	-	0.2	0.3	%/V	②
Input Voltage	V_{IN}		1.8	-	10	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{\Delta T_{opr} \cdot \Delta V_{OUT}}$	$I_{OUT}=40mA$ $-40^\circ C \leq T_{opr} \leq 85^\circ C$	-	± 100	-	ppm/ $^\circ C$	②

XC6201P182 $V_{OUT(T)}=1.8V$ (*1)

$T_a=25^\circ C$

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	$V_{OUT(E)}$ (*2)	$V_{IN}=2.8V$ $I_{OUT}=40mA$	1.764	1.800	1.836	V	②
Maximum Output Current	I_{OUTmax}	$V_{IN}=2.8V$ $V_{OUT(E)} \geq 1.62V$	80	-	-	mA	②
Load Regulation	ΔV_{OUT}	$V_{IN}=2.8V$ $1mA \leq I_{OUT} \leq 40mA$	-	10	30	mV	②
Dropout Voltage (*3)	Vdif1	$I_{OUT}=40mA$	-	200	370	mV	②
	Vdif2	$I_{OUT}=80mA$	-	450	710		
Supply Current	I_{SS}	$V_{IN}=2.8V$	-	2.0	5.0	μA	①
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot \Delta V_{OUT}}$	$I_{OUT}=40mA$ $2.8V \leq V_{IN} \leq 10.0V$	-	0.2	0.3	%/V	②
Input Voltage	V_{IN}		1.8	-	10	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{\Delta T_{opr} \cdot \Delta V_{OUT}}$	$I_{OUT}=40mA$ $-40^\circ C \leq T_{opr} \leq 85^\circ C$	-	± 100	-	ppm/ $^\circ C$	②

XC6201P272 $V_{OUT(T)}=2.7V$ (*1)

$T_a=25^\circ C$

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	$V_{OUT(E)}$ (*2)	$V_{IN}=3.7V$ $I_{OUT}=40mA$	2.646	2.700	2.754	V	②
Maximum Output Current	I_{OUTmax}	$V_{IN}=3.7V$ $V_{OUT(E)} \geq 2.43V$	100	-	-	mA	②
Load Regulation	ΔV_{OUT}	$V_{IN}=3.7V$ $1mA \leq I_{OUT} \leq 60mA$	-	15	40	mV	②
Dropout Voltage (*3)	Vdif1	$I_{OUT}=60mA$	-	200	370	mV	②
	Vdif2	$I_{OUT}=120mA$	-	450	710		
Supply Current	I_{SS}	$V_{IN}=3.7V$	-	2.0	5.0	μA	①
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot \Delta V_{OUT}}$	$I_{OUT}=40mA$ $3.7V \leq V_{IN} \leq 10.0V$	-	0.2	0.3	%/V	②
Input Voltage	V_{IN}		1.8	-	10	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{\Delta T_{opr} \cdot \Delta V_{OUT}}$	$I_{OUT}=40mA$ $-40^\circ C \leq T_{opr} \leq 85^\circ C$	-	± 100	-	ppm/ $^\circ C$	②

■ ELECTRICAL CHARACTERISTICS (Continued)

XC6201P302

 $V_{OUT(T)}=3.0V$ (*1)

 $T_a=25^\circ C$

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	$V_{OUT(E)}$ (*2)	$V_{IN}=4.0V$ $I_{OUT}=40mA$	2.940	3.000	3.060	V	②
Maximum Output Current	I_{OUTmax}	$V_{IN}=4.0V$ $V_{OUT(E)} \geq 2.7V$	150	-	-	mA	②
Load Regulation	ΔV_{OUT}	$V_{IN}=4.0V$ $1mA \leq I_{OUT} \leq 80mA$	-	20	50	mV	②
Dropout Voltage (*3)	Vdif1	$I_{OUT}=80mA$	-	200	360	mV	②
	Vdif2	$I_{OUT}=160mA$	-	450	700		
Supply Current	I_{SS}	$V_{IN}=4.0V$	-	2.0	5.0	μA	①
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot \Delta V_{OUT}}$	$I_{OUT}=40mA$ $4.0V \leq V_{IN} \leq 10.0V$	-	0.2	0.3	%/V	②
Input Voltage	V_{IN}		1.8	-	10	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{\Delta T_{opr} \cdot \Delta V_{OUT}}$	$I_{OUT}=40mA$ $-40^\circ C \leq T_{opr} \leq 85^\circ C$	-	± 100	-	ppm/ $^\circ C$	②

XC6201P332

 $V_{OUT(T)}=3.3V$ (*1)

 $T_a=25^\circ C$

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	$V_{OUT(E)}$ (*2)	$V_{IN}=4.3V$ $I_{OUT}=40mA$	3.234	3.300	3.366	V	②
Maximum Output Current	I_{OUTmax}	$V_{IN}=4.3V$ $V_{OUT(E)} \geq 2.97V$	150	-	-	mA	②
Load Regulation	ΔV_{OUT}	$V_{IN}=4.3V$ $1mA \leq I_{OUT} \leq 80mA$	-	20	50	mV	②
Dropout Voltage (*3)	Vdif1	$I_{OUT}=80mA$	-	200	360	mV	②
	Vdif2	$I_{OUT}=160mA$	-	450	700		
Supply Current	I_{SS}	$V_{IN}=4.3V$	-	2.0	5.0	μA	①
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot \Delta V_{OUT}}$	$I_{OUT}=40mA$ $4.3V \leq V_{IN} \leq 10.0V$	-	0.2	0.3	%/V	②
Input Voltage	V_{IN}		1.8	-	10	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{\Delta T_{opr} \cdot \Delta V_{OUT}}$	$I_{OUT}=40mA$ $-40^\circ C \leq T_{opr} \leq 85^\circ C$	-	± 100	-	ppm/ $^\circ C$	②

XC6201P502

 $V_{OUT(T)}=5.0V$ (*1)

 $T_a=25^\circ C$

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	$V_{OUT(E)}$ (*2)	$V_{IN}=6.0V$ $I_{OUT}=40mA$	4.900	5.000	5.100	V	②
Maximum Output Current	I_{OUTmax}	$V_{IN}=6.0V$ $V_{OUT(E)} \geq 4.57V$	200	-	-	mA	②
Load Regulation	ΔV_{OUT}	$V_{IN}=6.0V$ $1mA \leq I_{OUT} \leq 100mA$	-	30	70	mV	②
Dropout Voltage (*3)	Vdif1	$I_{OUT}=100mA$	-	160	340	mV	②
	Vdif2	$I_{OUT}=200mA$	-	400	600		
Supply Current	I_{SS}	$V_{IN}=6.0V$	-	2.0	6.0	μA	①
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot \Delta V_{OUT}}$	$I_{OUT}=40mA$ $6.0V \leq V_{IN} \leq 10.0V$	-	0.2	0.3	%/V	②
Input Voltage	V_{IN}		1.8	-	10	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{\Delta T_{opr} \cdot \Delta V_{OUT}}$	$I_{OUT}=40mA$ $-40^\circ C \leq T_{opr} \leq 85^\circ C$	-	± 100	-	ppm/ $^\circ C$	②

■ ELECTRICAL CHARACTERISTICS (Continued)

NOTE:

*1: $V_{OUT(T)}$ = Nominal output voltage.

*2: $V_{OUT(E)}$ = Effective output voltage (i.e. the output voltage when " $V_{OUT(T)}+1.0V$ " is provided while maintaining a certain I_{OUT} value).

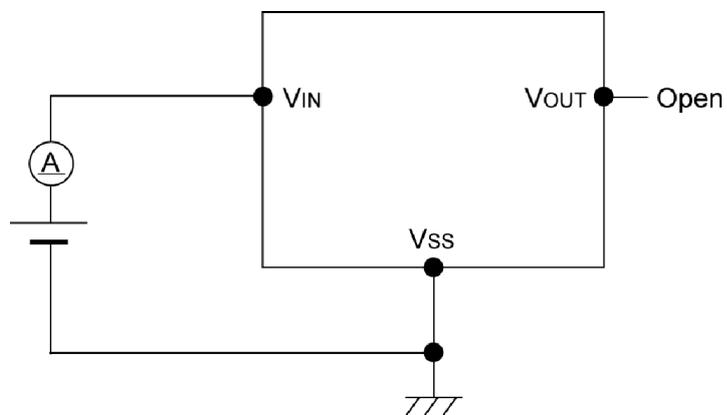
*3: $V_{dif} = (V_{IN1} - V_{OUT1})$

V_{IN1} :An Input Voltage when V_{OUT1} appears as the input voltage is gradually decreased.

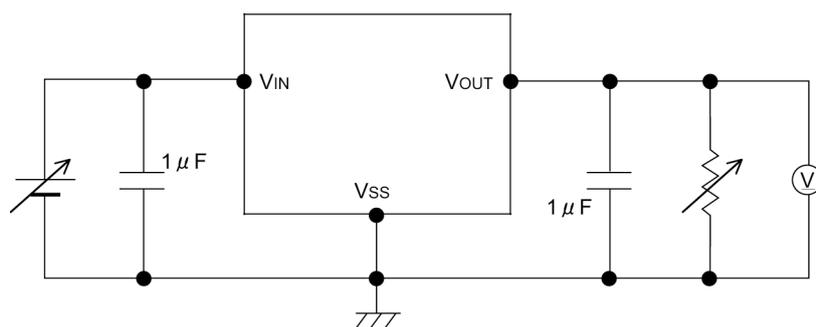
V_{OUT1} : A voltage equal to 98% of the output voltage when a stabilized ($V_{OUT(T)} + 1.0V$) is input.

■ TEST CIRCUITS

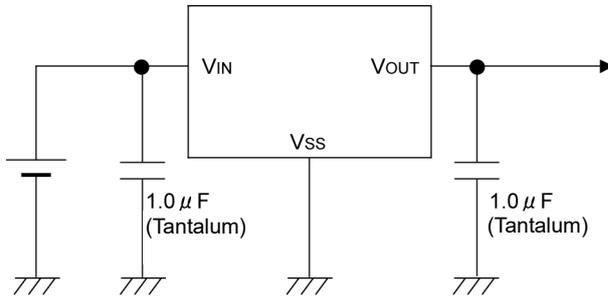
Circuit ① : Supply Current



Circuit ② : Output Voltage, Oscillation, Line Regulation, Dropout Voltage, Load Regulation

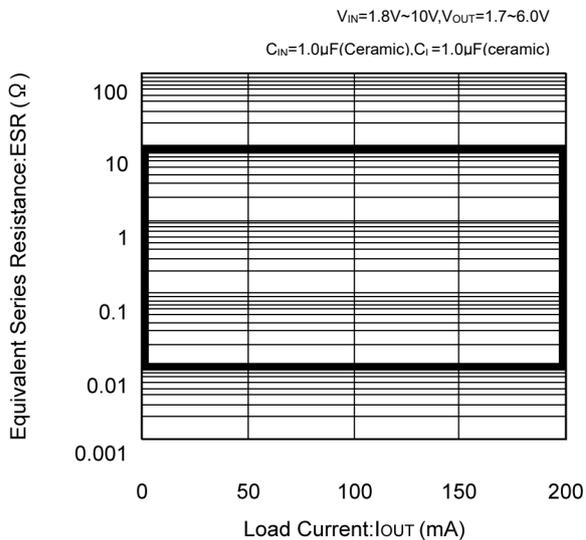


OPERATIONAL EXPLANATION



With the XC6201 series regulator, in order to ensure the stabilized output voltage, we suggest that an output capacitor (C_L) of $1\ \mu\text{F}$ or more be connected between the output pin (V_{OUT}) and the V_{SS} pin. For using low ESR capacitor (e.g. ceramic capacitors), please make sure that the output voltage is more than 1.7V. When the output voltage is from 1.3V to 1.6V, the output capacitor should be a tantalum capacitor with a capacitance of $2.2\ \mu\text{F}$. We also suggest an input capacitor (C_{IN}) should be connected between the V_{IN} and the V_{SS} in order to stabilize input power source.

OUTPUT VOLTAGE	C_{IN}	C_L (TANTALUM)	C_L (LOW ESR)
1.3V ~ 1.6V	$\geq 1.0\ \mu\text{F}$	$\geq 2.2\ \mu\text{F}$	-
1.7V ~ 6.0V	$\geq 1.0\ \mu\text{F}$	$\geq 1.0\ \mu\text{F}$	$\geq 1.0\ \mu\text{F}$



■ NOTE ON USE

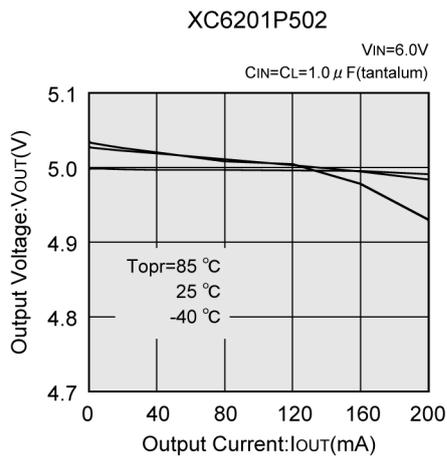
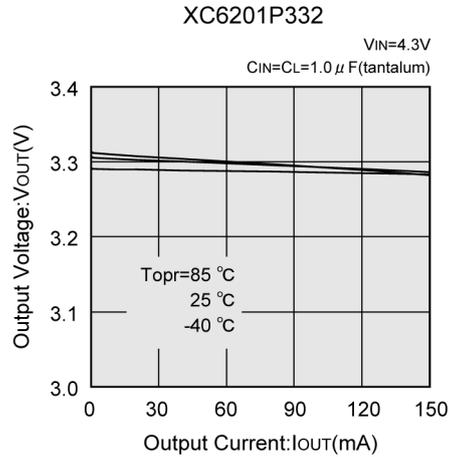
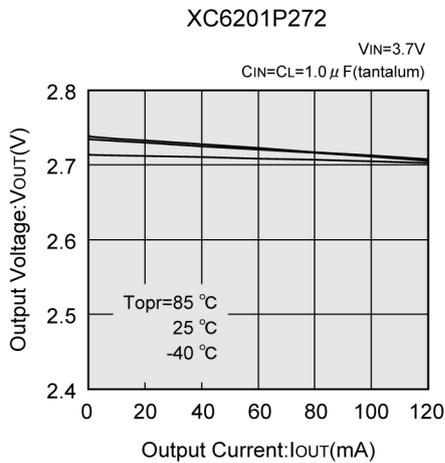
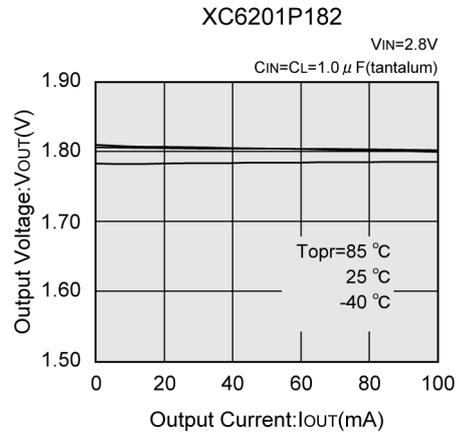
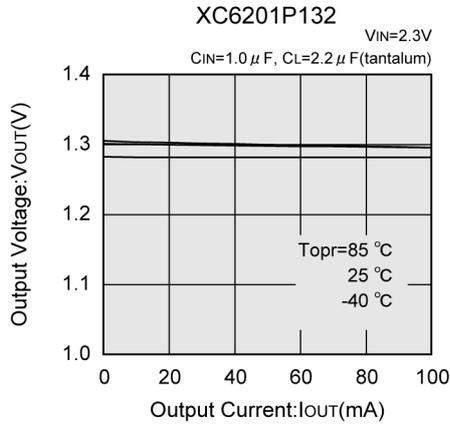
1. Please use this IC within the stated absolute maximum ratings. The IC is liable to malfunction should the ratings be exceeded. When a voltage higher than the V_{IN} flows to the V_{OUT} like when using two power supplies, please connect a Schottky barrier diode between the V_{OUT} and the V_{IN} and do not exceed the V_{OUT} rating.

2. An oscillation may occur by the impedance between a power supply and the input of the IC. Where the impedance is $10\ \Omega$ or more, please use an input capacitor (C_{IN}) of at least $1\ \mu\text{F}$. In case of high output current, operation can be stabilized by increasing the input capacitor value. Also an oscillation may occur if the input capacitor value is smaller than the input impedance when the output capacitance (C_L) is large. In such cases, operations can be stabilized by either increasing the input capacitor value or reducing the output capacitor value.

3. Please ensure that output current (I_{OUT}) is less than $P_d / (V_{IN} - V_{OUT})$ and do not exceed the rated power dissipation value (P_d) of the package.

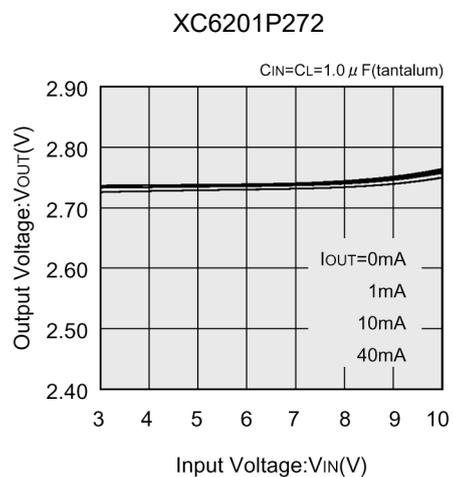
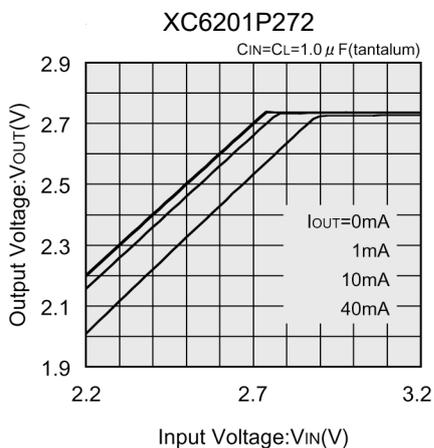
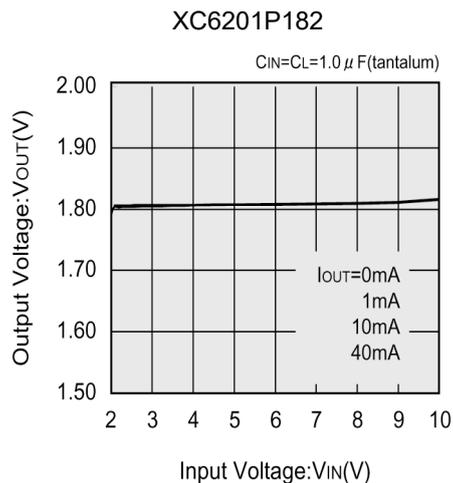
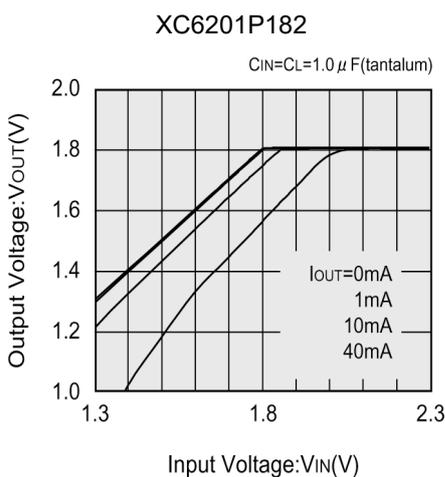
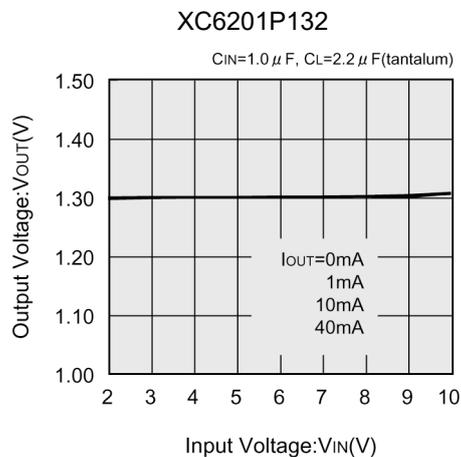
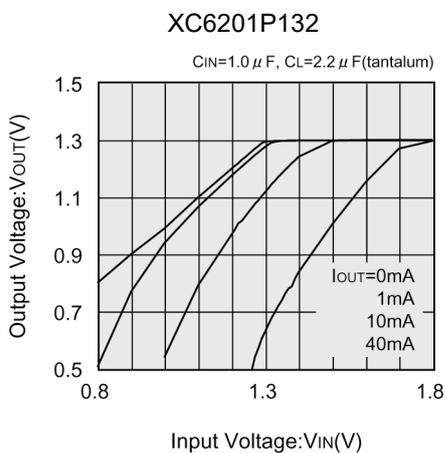
TYPICAL PERFORMANCE CHARACTERISTICS

(1) Output Voltage vs. Output Current



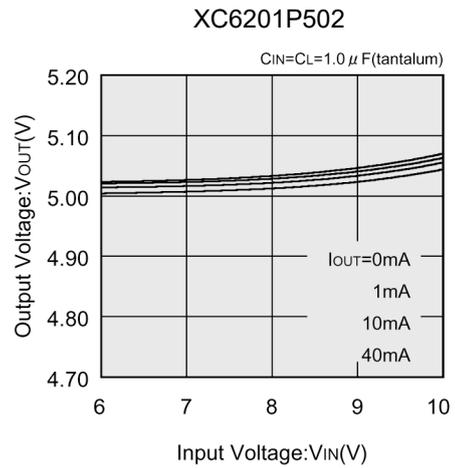
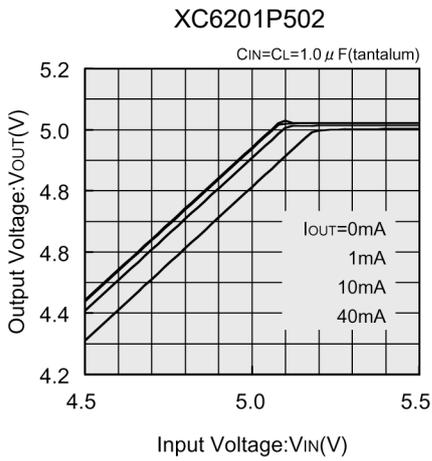
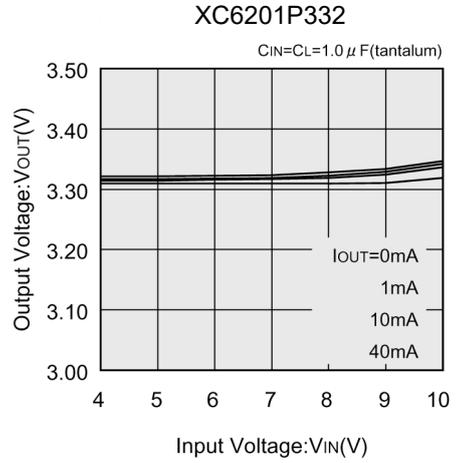
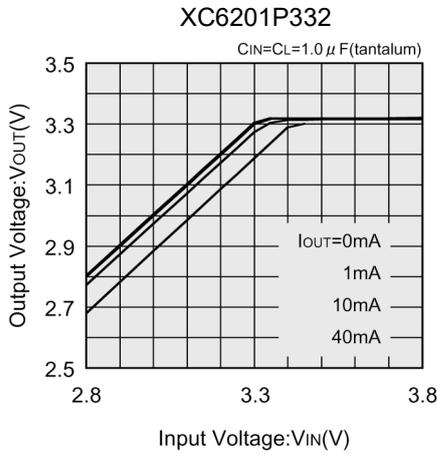
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(2) Output Voltage vs. Input Voltage



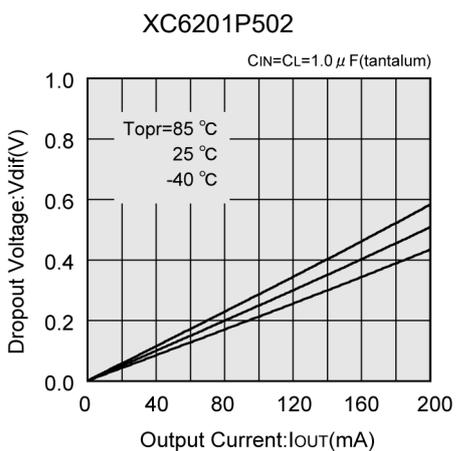
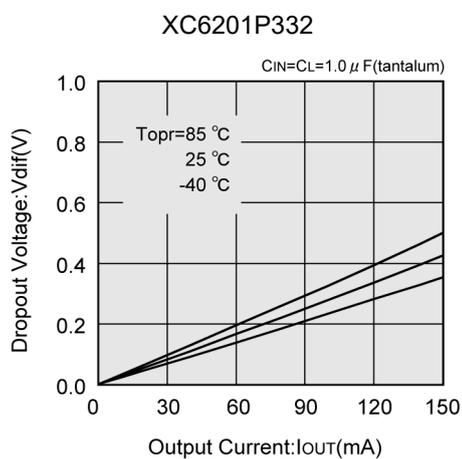
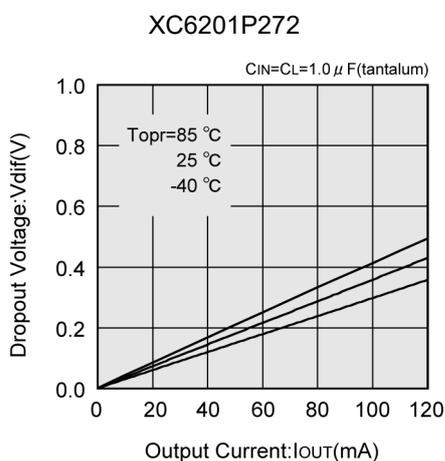
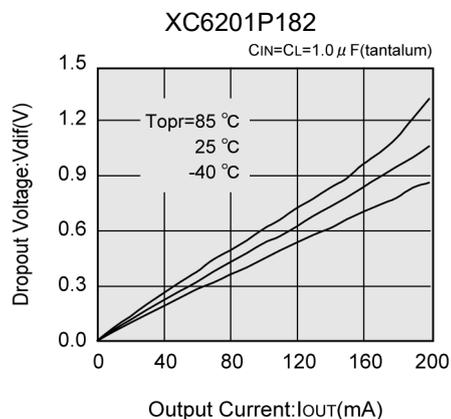
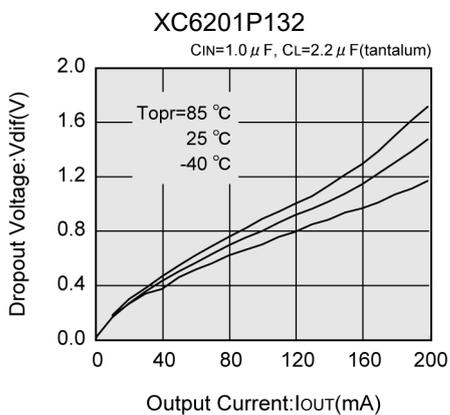
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(2) Output Voltage vs. Input Voltage (Continued)



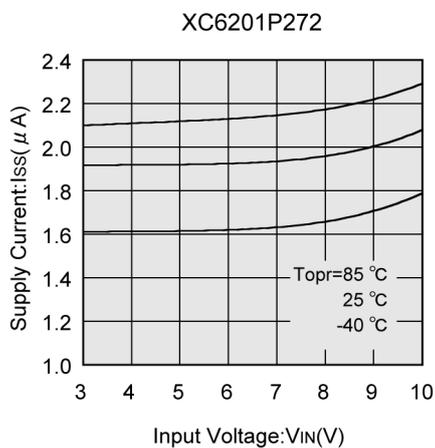
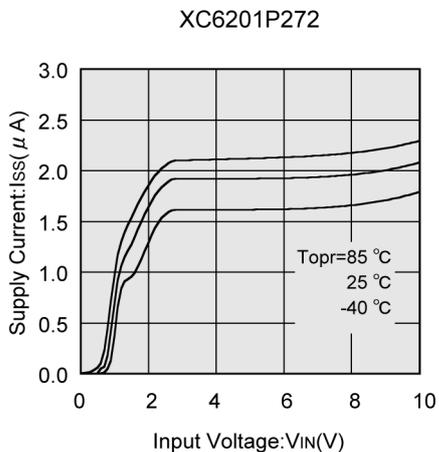
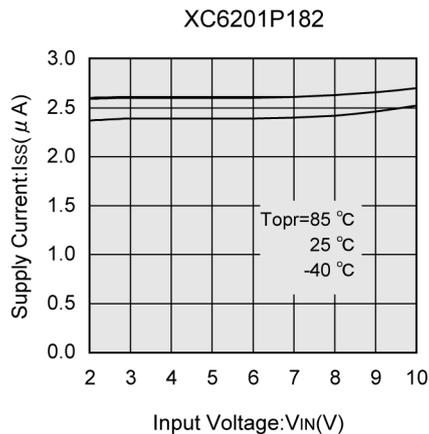
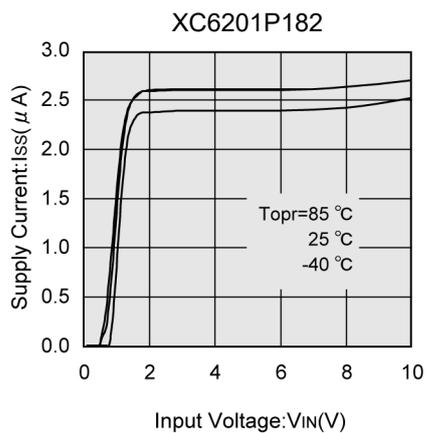
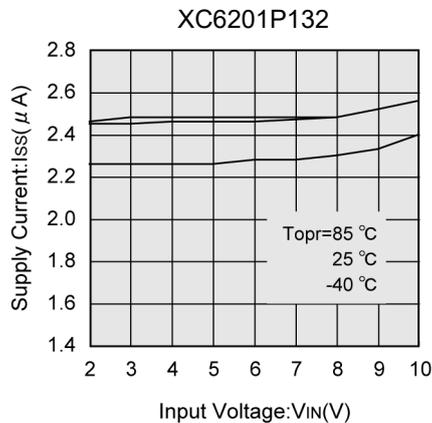
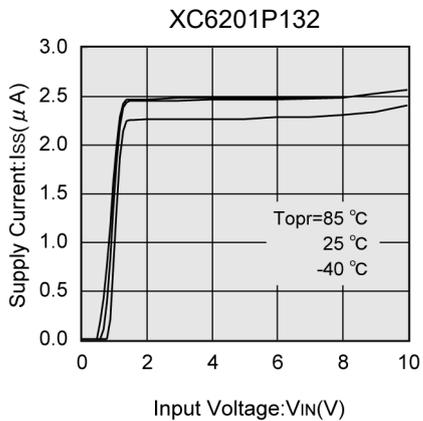
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Dropout Voltage vs. Output Current



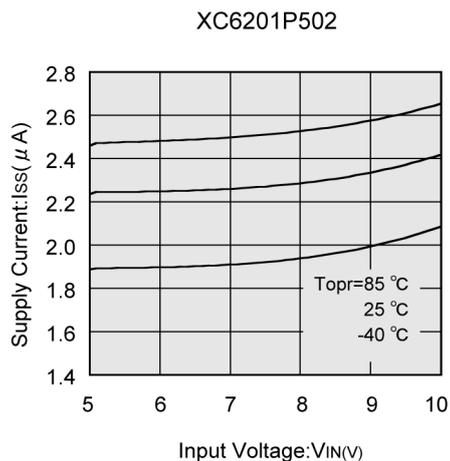
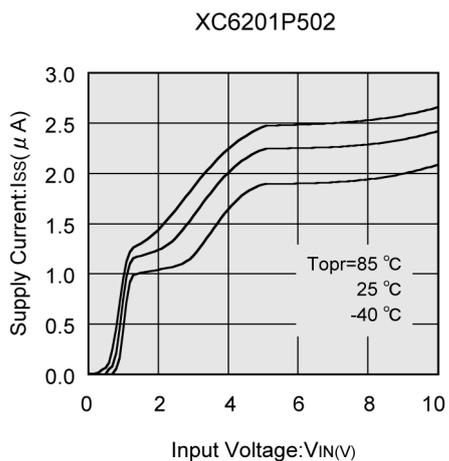
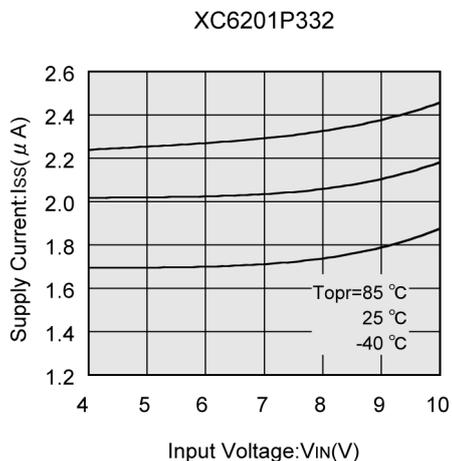
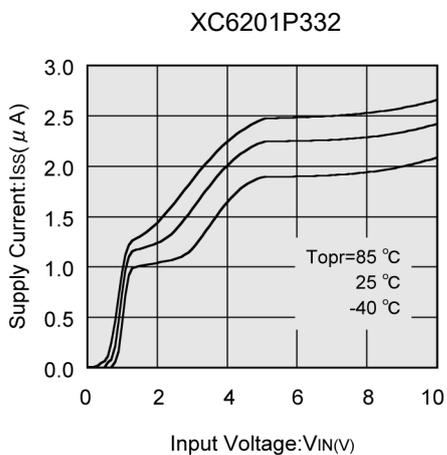
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(4) Supply Current vs. Input Voltage



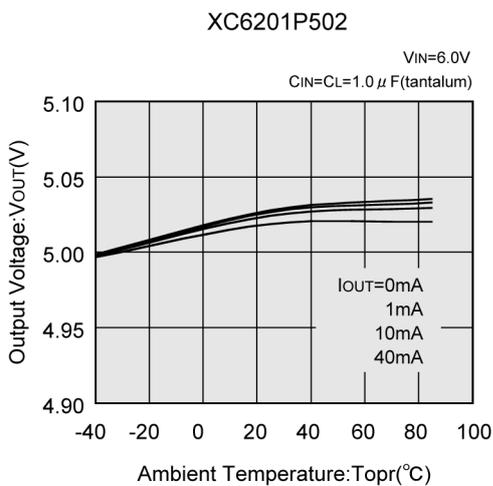
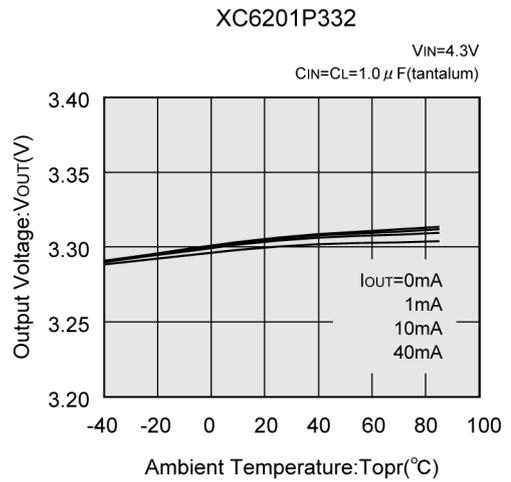
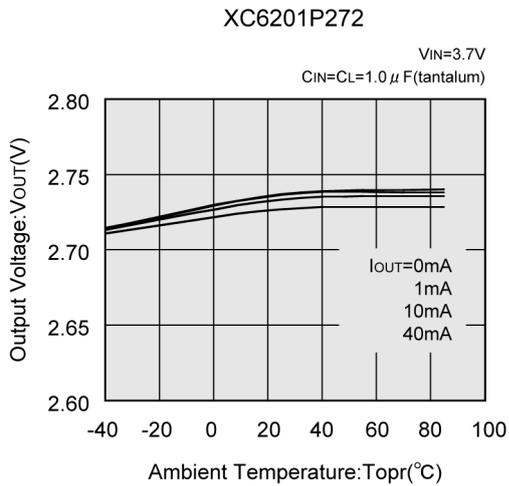
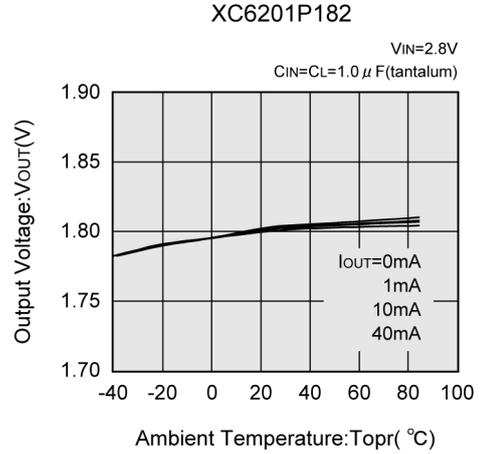
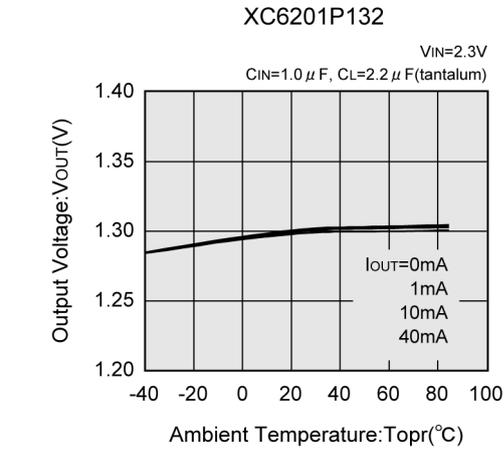
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(4) Supply Current vs. Input Voltage (Continued)



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

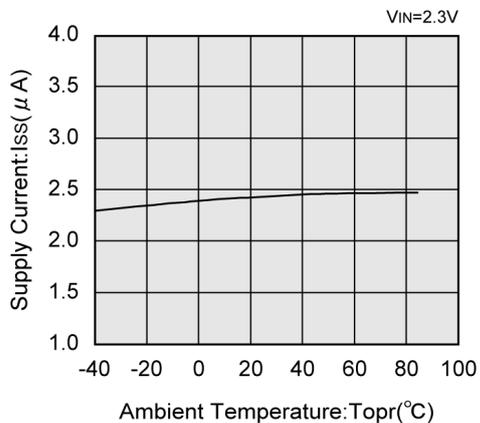
(5) Output Voltage vs. Ambient Temperature



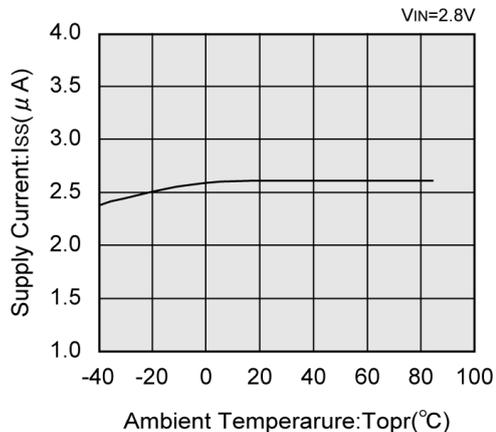
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(6) Supply Current vs. Ambient Temperature

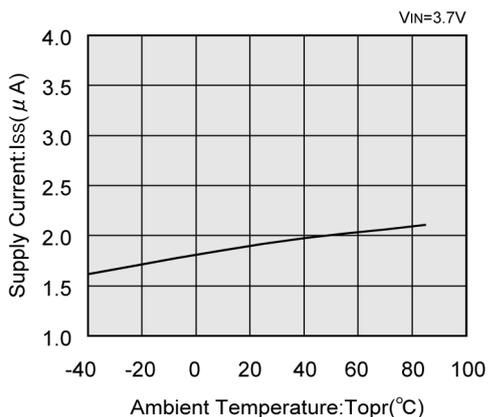
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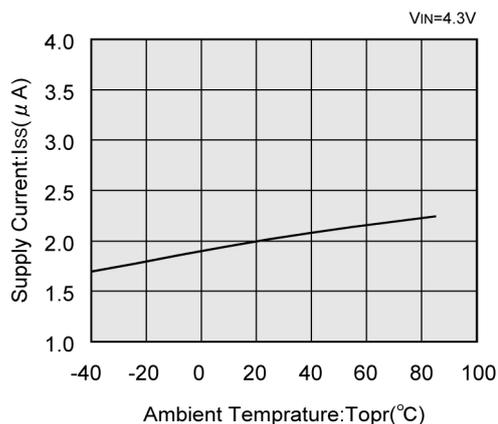
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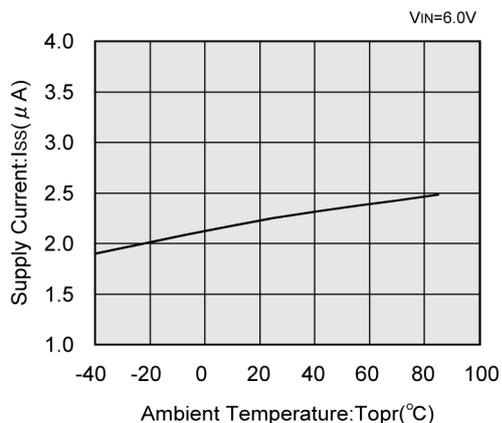
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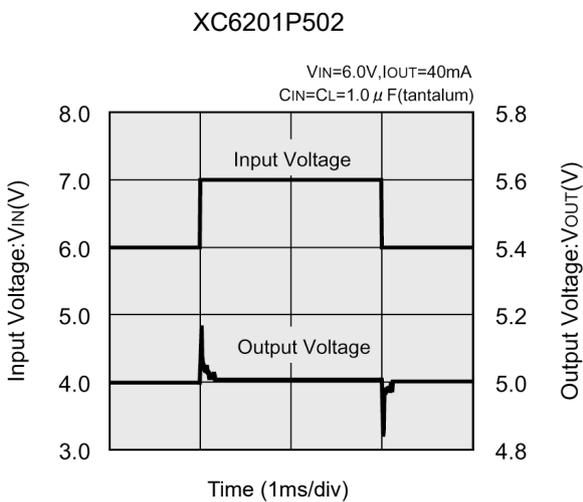
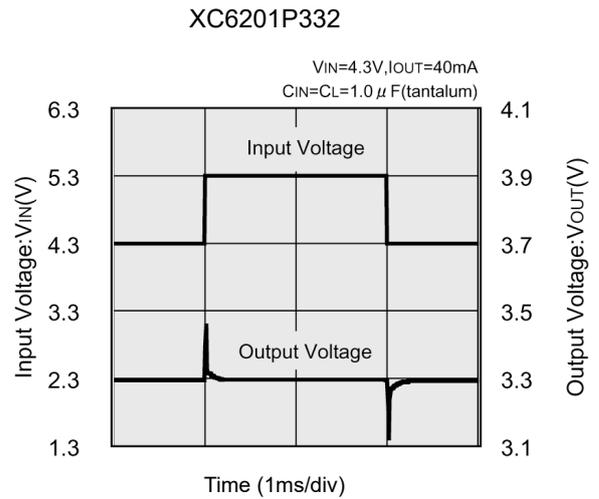
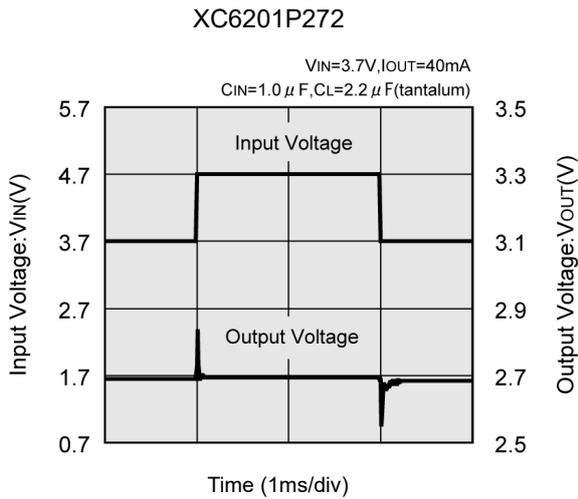
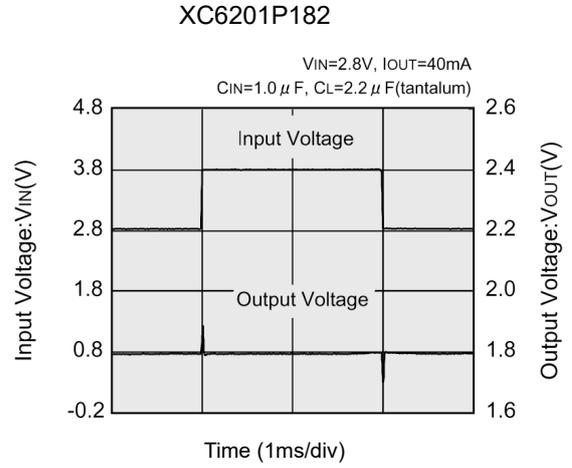
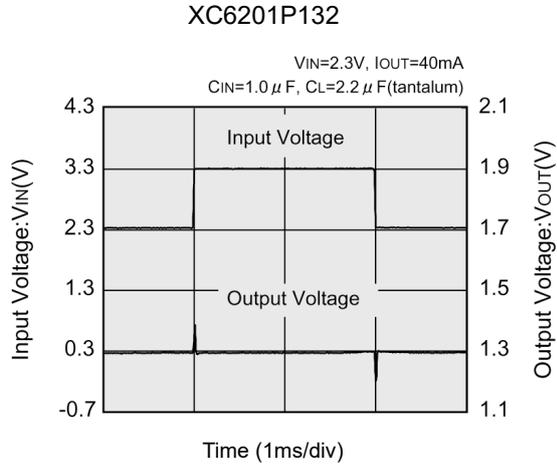


XC6201P502



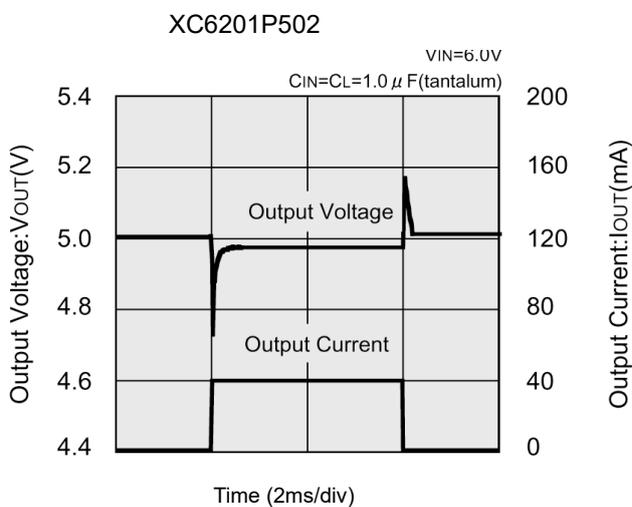
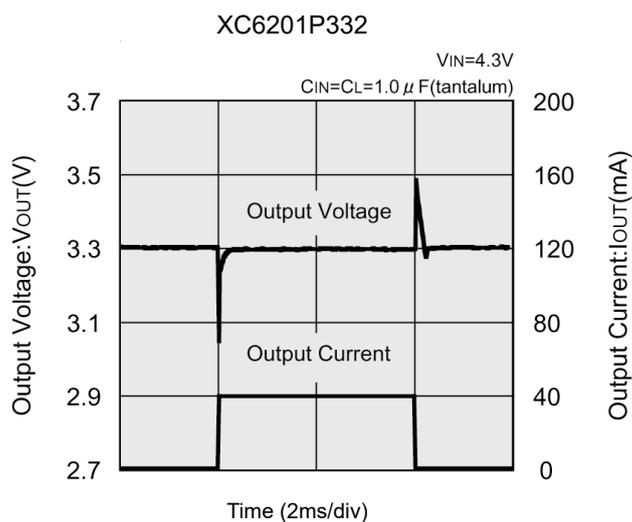
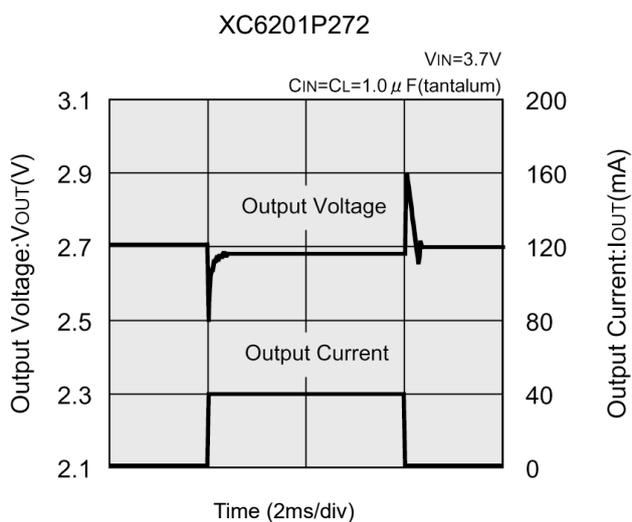
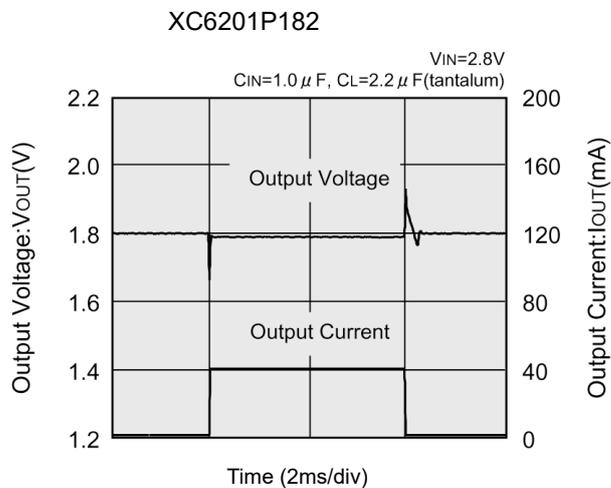
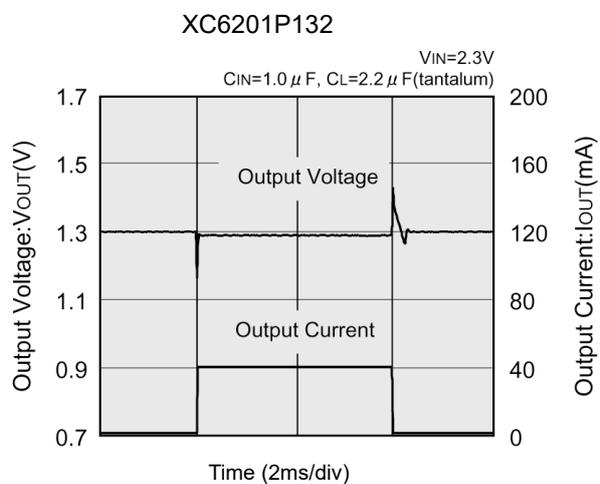
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(7) Input Transient Response



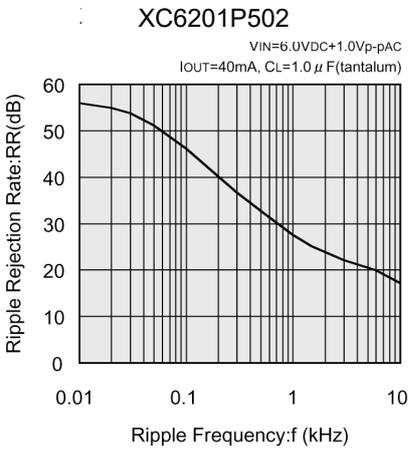
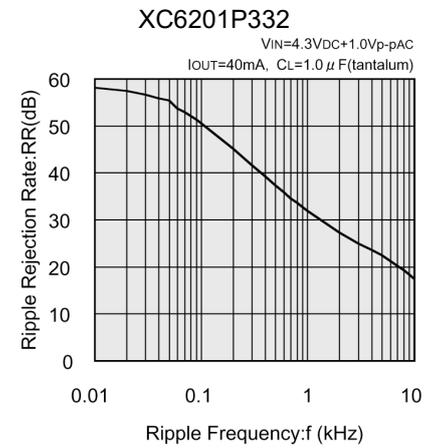
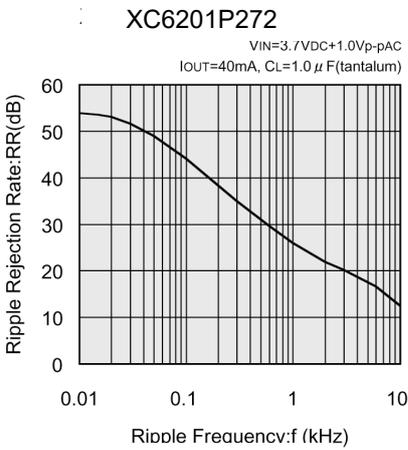
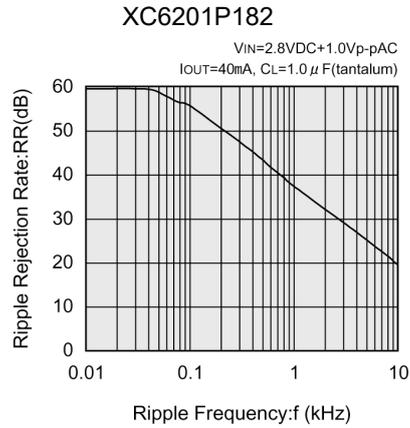
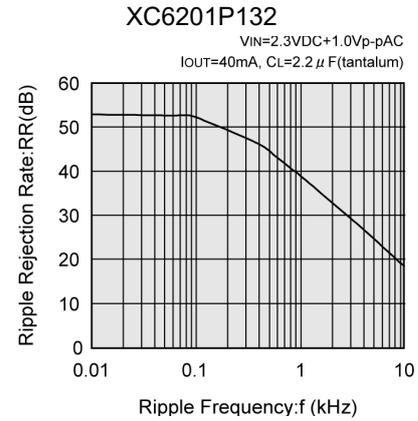
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Load Transient Response

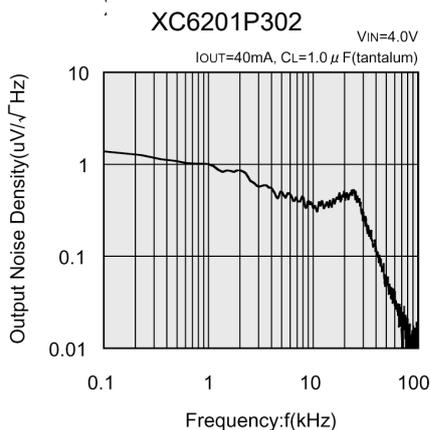


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Ripple Rejection Rate



(10) Output Noise Density



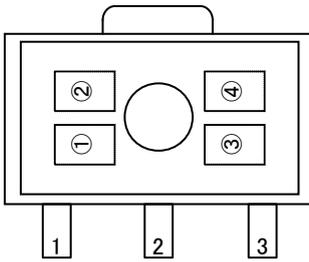
■ PACKAGING INFORMATION

For the latest package information go to, www.torexsemi.com/technical-support/packages

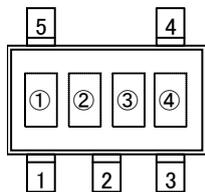
PACKAGE	OUTLINE / LAND PATTERN	THERMAL CHARACTERISTICS
SOT-25	SOT-25 PKG	SOT-25 Power Dissipation
SOT-89	SOT-89 PKG	SOT-89 Power Dissipation
USP-6B	USP-6B PKG	USP-6B Power Dissipation

MARKING RULE

● SOT-89, SOT-25



SOT-89
(TOP VIEW)



SOT-25
(TOP VIEW)

① represents the product series

MARK	PRODUCT SERIES
1	XC6201xxxxxx

② represents type of regulator

MARK		PRODUCT SERIES
Voltage= 0.1 ~ 3.0V	Voltage= 3.1 ~ 6.0V	
5	6	XC6201Pxxxxx
8	9	XC6201TxxxxPx

③ represents output voltage

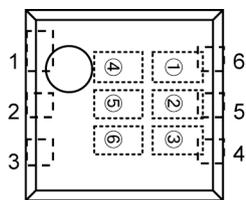
MARK	OUTPUT VOLTAGE (V)			MARK	OUTPUT VOLTAGE (V)		
0	—	3.1	—	F	1.6	4.6	—
1	—	3.2	—	H	1.7	4.7	—
2	—	3.3	—	K	1.8	4.8	—
3	—	3.4	—	L	1.9	4.9	—
4	—	3.5	—	M	2.0	5.0	—
5	—	3.6	—	N	2.1	5.1	—
6	—	3.7	—	P	2.2	5.2	—
7	—	3.8	—	R	2.3	5.3	—
8	—	3.9	—	S	2.4	5.4	—
9	—	4.0	—	T	2.5	5.5	—
A	—	4.1	—	U	2.6	5.6	—
B	—	4.2	—	V	2.7	5.7	—
C	1.3	4.3	—	X	2.8	5.8	—
D	1.4	4.4	—	Y	2.9	5.9	—
E	1.5	4.5	—	Z	3.0	6.0	—

④ represents assembly lot number

0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)

MARKING RULE (Continued)

● USP-6B



USP-6B
(TOP VIEW)

①② represents product series

③ represents type of regulator

MARK	TYPE	PRODUCT SERIES
P	3pin Regulator	XC6201PxxxDx
T	V _{IN} =7V(Rated)	XC6201TxxxDx

④⑤ represents output voltage

MARK		VOLTAGE (V)	PRODUCT SERIES
④	⑤		
3	3	3.3	XC6201x33xDx
5	0	5.0	XC6201x50xDx

⑥ represents assembly lot number
0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)
Note: No character inversion used.

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